

Product Summary

V_{BR} Min	I_{PP} Max	C_{IN} Typ
8.5V	3.5A	8.5pF

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Applications

- Cellular handsets
- Portable electronics
- Computers and peripherals

Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±25kV, Contact ±25kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **The DIODES™ D8V0L1B2LP3Q is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.**

<https://www.diodes.com/quality/product-definitions/>

Mechanical Data

- Package: X3-DFN0603-2
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin over Copper Leadframe, per MIL-STD-202, Method 208
- Weight: 0.0002 grams (Approximate)

X3-DFN0603-2



Device Schematic

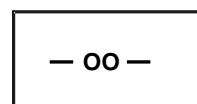
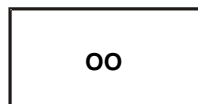


Ordering Information (Note 4)

Part Number	Package	Marking	Reel Size (inches)	Tape Width (mm)	Packing	
					Qty.	Carrier
D8V0L1B2LP3Q-7	X3-DFN0603-2	OO or -OO-	7	8	10,000	Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



OO or -OO- = Product Type Marking Code

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	PPP	66	W	8/20μs, per Figure 3
Peak Pulse Current	I _{PP}	3.5	A	8/20μs, per Figure 3
ESD Protection – Contact Discharge	V _{ESD_CONTACT}	±25	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V _{ESD_AIR}	±25	kV	IEC 61000-4-2 Standard

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Standoff Voltage	V _{RWM}	—	—	8	V	—
Channel Leakage Current (Note 6)	I _{RM}	—	—	50	nA	V _{RWM} = 8V
Breakdown Voltage	V _{BR}	8.5	—	12	V	I _R = 1mA
Clamping Voltage, Positive Transients	V _{CL}	—	—	12.5	V	I _{PP} = 1A, t _P = 8/20μs
		—	—	16.5		I _{PP} = 3.5A, t _P = 8/20μs
ESD Clamping Voltage (Note 7)	V _C	—	12.6	—	V	I _{PP} = 4A, t _P = 10/100ns
		—	18.3	—		I _{PP} = 16A, t _P = 10/100ns
		—	24.5	—		I _{PP} = 30A, t _P = 10/100ns
Differential Resistance	R _{DYN}	—	0.4	—	Ω	I _{TLP} = 10A to 20A, t _P = 100ns, I/O to GND
Channel Input Capacitance	C _{IN}	—	8.5	—	pF	V _R = 0V, f = 1MHz

- Notes:
- Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
 - Short duration pulse test used to minimize self-heating effect.
 - Transmission Line Pulse Test (TLP) settings: t_p=100ns, t_r=10ns, I_{TLP} and V_{TLP} averaging window is from 70ns to 90ns.

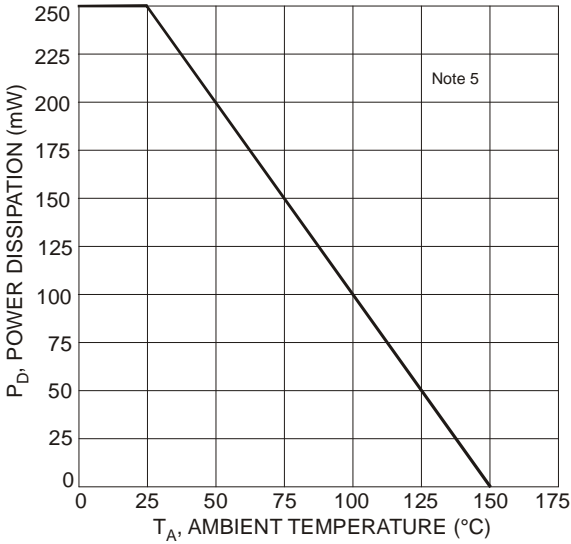


Figure 1 Power Derating Curve

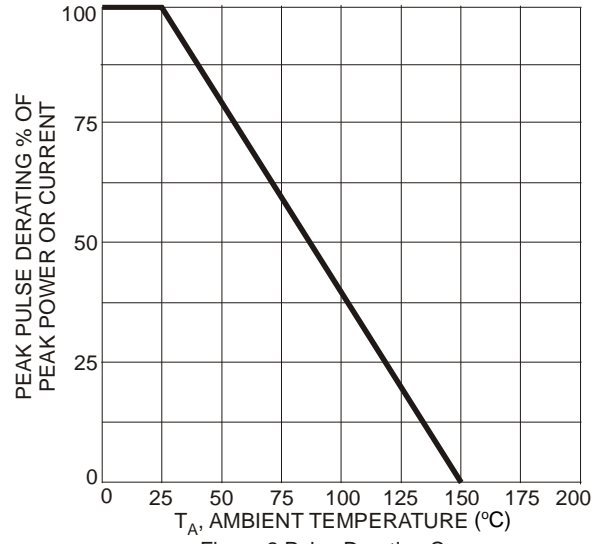


Figure 2 Pulse Derating Curve

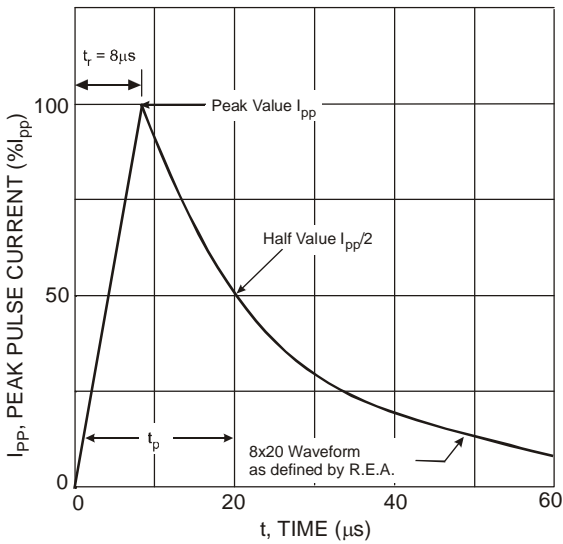


Figure 3 Pulse Waveform

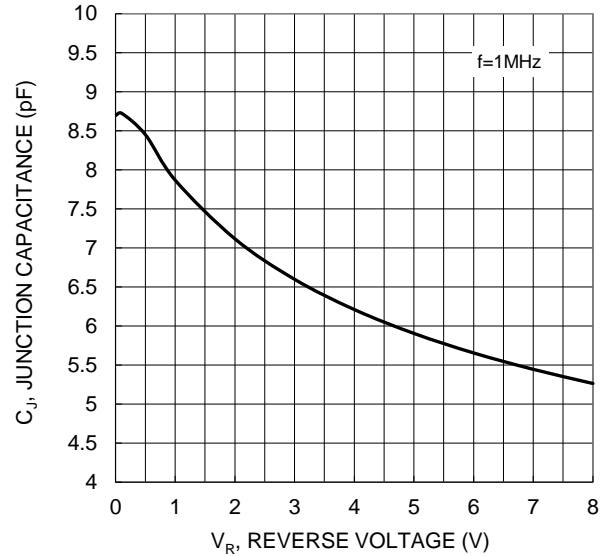


Figure 4 Typical Junction Capacitance

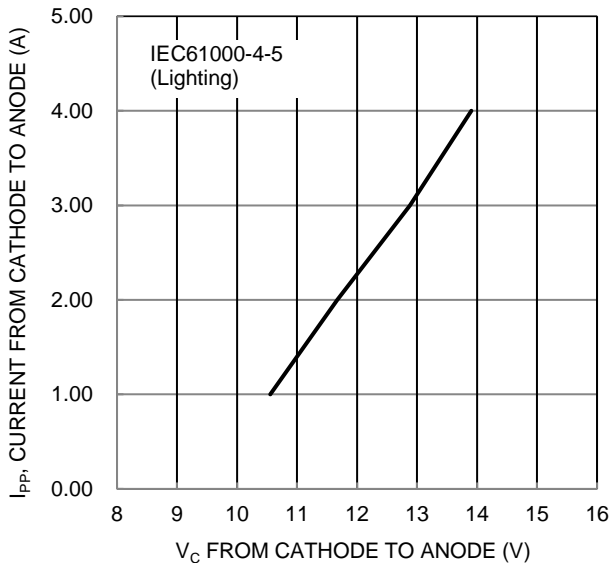


Figure 5 Clamping Voltage Characteristic

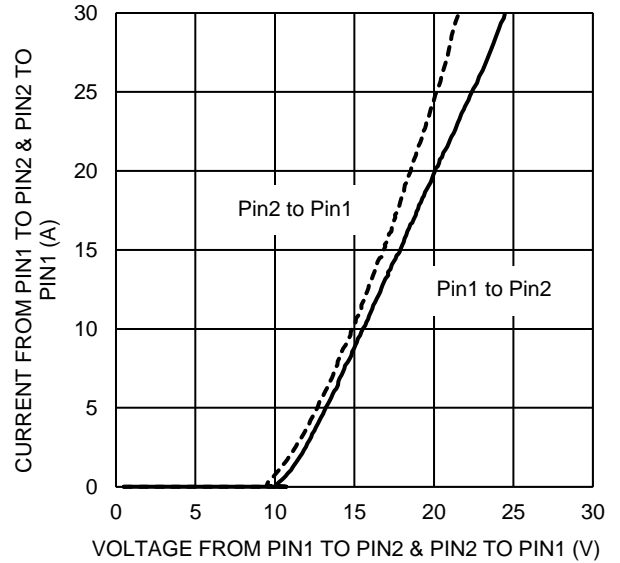
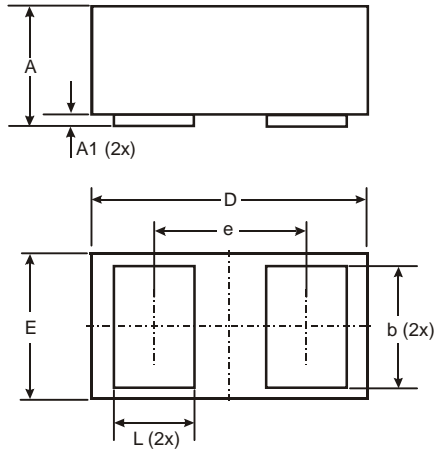


Figure 6 TLP Curve ($t_p = 100\text{ns}$)

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

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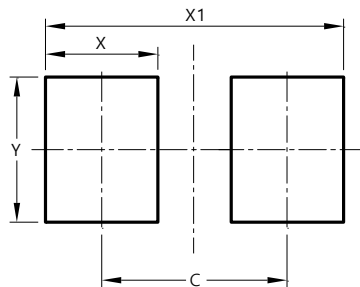


X3-DFN0603-2			
Dim	Min	Max	Typ
A	0.27	0.35	0.30
A1	0.00	0.03	0.02
b	0.19	0.29	0.24
D	0.595	0.645	0.62
E	0.295	0.345	0.32
e	-	-	0.355
L	0.14	0.24	0.19
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X3-DFN0603-2



Dimensions	Value (in mm)
C	0.380
X	0.230
X1	0.610
Y	0.300

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